MOSFETs Silicon N-Channel MOS (π-MOSⅣ)

TK1P90A

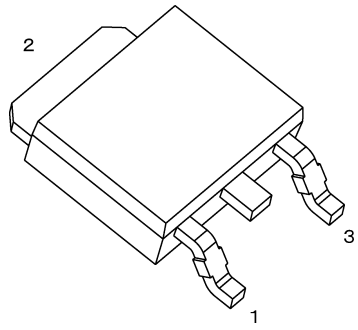
1. Applications

- Switching Voltage Regulators

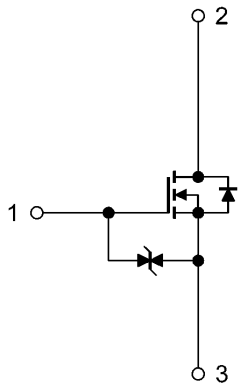
2. Features

(1) Low drain-source on-resistance: $R_{DS(ON)}$ = 6.7 Ω (typ.)
(2) High forward transfer admittance: $|Y_{fs}|$ = 1.0 S (typ.)
(3) Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 720 V)
(4) Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

3. Packaging and Internal Circuit



New PW-Mold



1: Gate (G)
2: Drain (D) (Heatsink)
3: Source (S)

4. Absolute Maximum Ratings (Note) (T_a = 25°C unless otherwise specified)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	900	V
Gate-source voltage		V_{GSS}	±30	
Drain current (DC)	(Note 1)	I_D	1	A
Drain current (pulsed)	(Note 1)	I_{DP}	3	
Power dissipation	(T_c = 25°C)	P_D	20	W
Single-pulse avalanche energy	(Note 2)	E_{AS}	216	mJ
Avalanche current		I_{AR}	1	A
Repetitive avalanche energy	(Note 3)	E_{AR}	2.0	mJ
Channel temperature		T_{ch}	150	°C
Storage temperature		T_{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production
2011-04

2013-12-25
Rev.2.0

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{th(ch-c)}$	6.25	°C/W
Channel-to-ambient thermal resistance	$R_{th(ch-a)}$	125	

Note 1: Ensure that the channel temperature does not exceed 150°C.
Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 396 mH, R_G = 25 Ω, I_{AR} = 1 A
Note 3: Repetitive rating; pulse width limited by maximum channel temperature

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

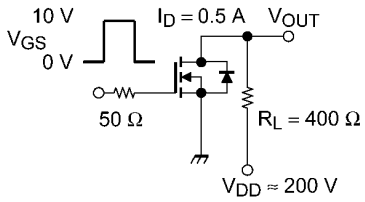
6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	—	—	±10	μA
Drain cut-off current	I_{DSS}	V_{DS} = 720 V, V_{GS} = 0 V	—	—	100	
Gate-source breakdown voltage	$V_{(BR)GSS}$	I_G = ±10 μA, V_{DS} = 0 V	±30	—	—	V
Drain-source breakdown voltage	$V_{(BR)DSS}$	I_D = 10 mA, V_{GS} = 0 V	900	—	—	
Gate threshold voltage	V_{th}	V_{DS} = 10 V, I_D = 1 mA	2.0	—	4.0	
Drain-source on-resistance	$R_{DS(ON)}$	V_{GS} = 10 V, I_D = 0.5 A	—	6.7	9.0	Ω
Forward transfer admittance	$\|Y_{fs}\|$	V_{DS} = 10 V, I_D = 0.5 A	0.3	1.0	—	S

6.2. Dynamic Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	C_{iss}	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz	—	320	—	pF
Reverse transfer capacitance	C_{rss}		—	10	—	
Output capacitance	C_{oss}		—	35	—	
Switching time (rise time)	t_r	See Figure 6.2.1.	—	25	—	ns
Switching time (turn-on time)	t_{on}		—	60	—	
Switching time (fall time)	t_f		—	30	—	
Switching time (turn-off time)	t_{off}		—	155	—	



Duty ≤ 1 %, t_w = 10 μs

Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	V_{DD} ≈ 400 V, V_{GS} = 10 V, I_D = 1 A	—	13	—	nC
Gate-source charge	Q_{gs}		—	6	—	
Gate-drain charge	Q_{gd}		—	7	—	

6.4. Source-Drain Characteristics (T_a = 25°C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Reverse drain current (DC)	(Note 1)	I_{DR}	—	—	—	1	A
Reverse drain current (pulsed)	(Note 1)	I_{DRP}	—	—	—	3	
Diode forward voltage		V_{DSF}	I_{DR} = 1 A, V_{GS} = 0 V	—	—	-1.7	V
Reverse recovery time		t_{rr}	I_{DR} = 1 A, V_{GS} = 0 V $-dI_{DR}/dt$ = 100 A/μs	—	550	—	ns
Reverse recovery charge		Q_{rr}		—	2.2	—	μC

7. Marking (Note)

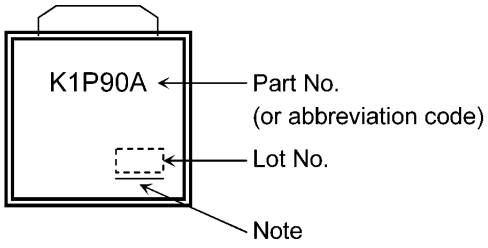


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.
Not underlined: [[Pb]]/INCLUDES > MCV
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

8. Characteristics Curves (Note)

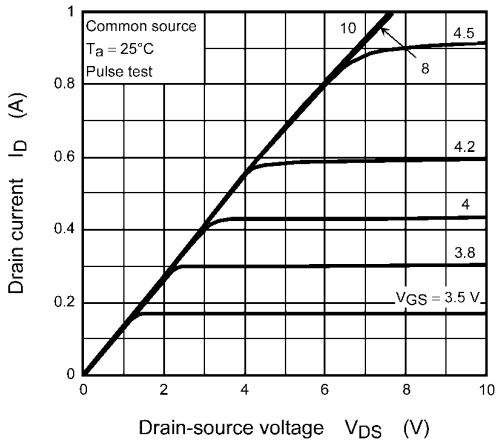


Fig. 8.1 I_D - V_{DS}

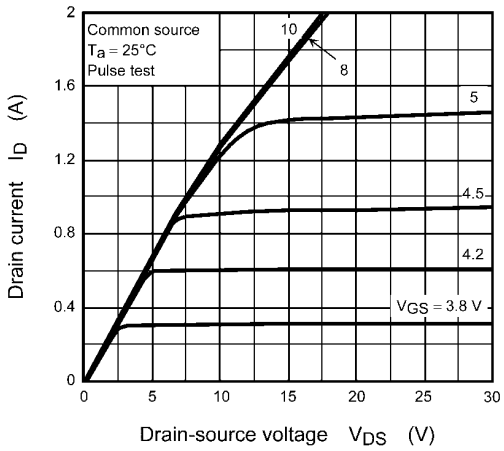


Fig. 8.2 I_D - V_{DS}

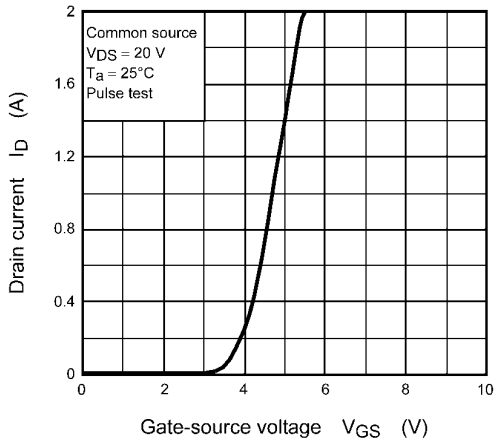


Fig. 8.3 I_D - V_{GS}

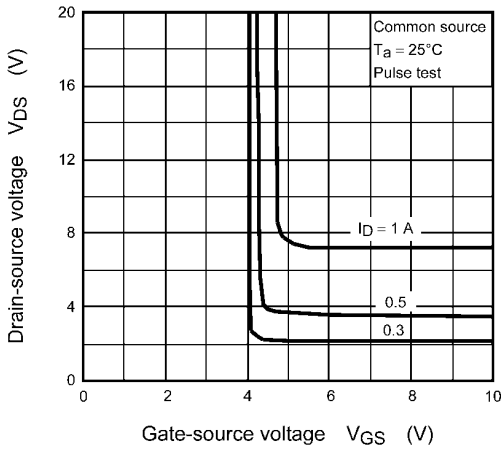


Fig. 8.4 V_{DS} - V_{GS}

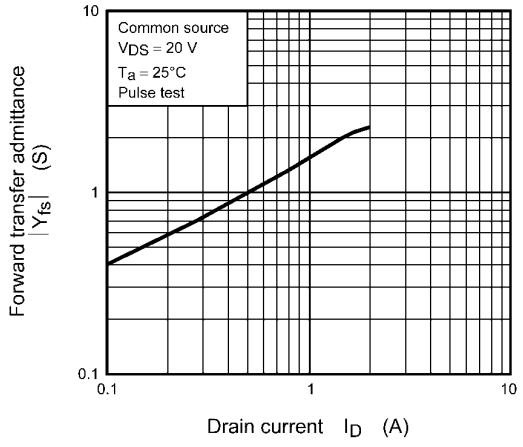


Fig. 8.5 $|Y_{fs}|$ - I_D

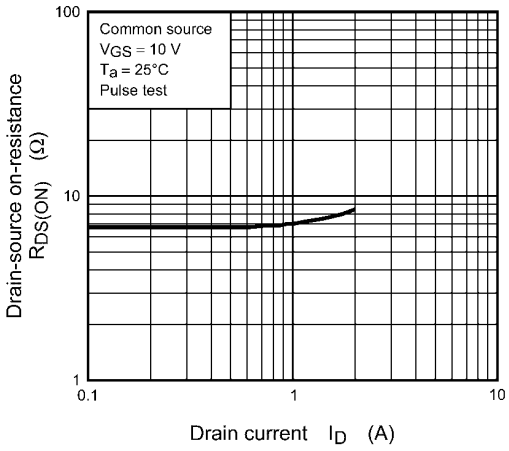


Fig. 8.6 $R_{DS(ON)}$ - I_D

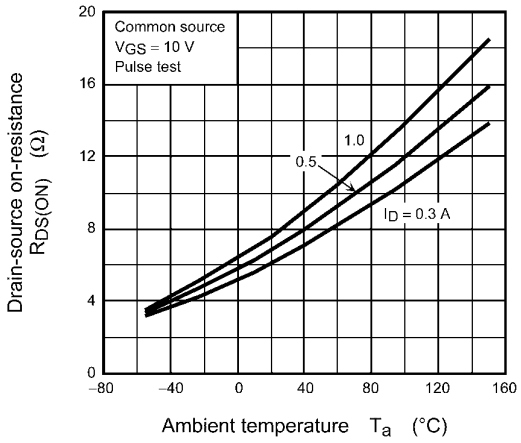


Fig. 8.7 $R_{DS(ON)}$ - T_a

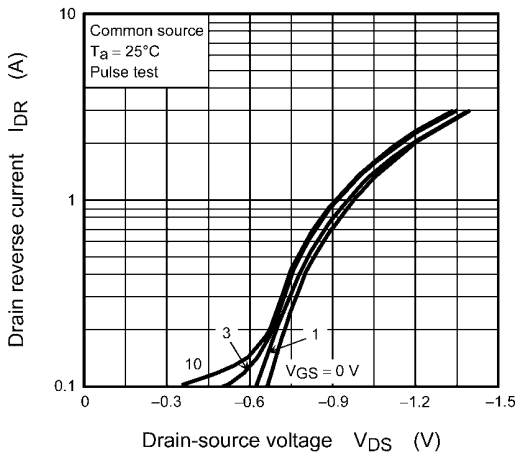


Fig. 8.8 I_{DR} - V_{DS}

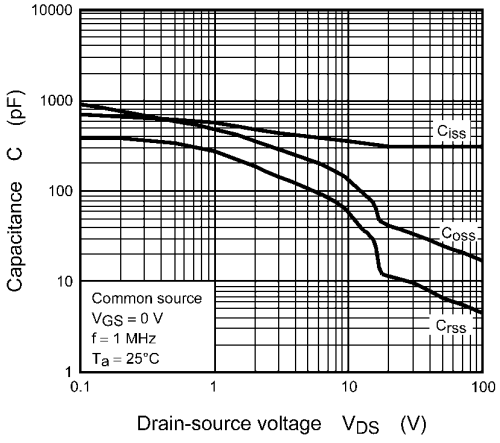


Fig. 8.9 C - V_{DS}

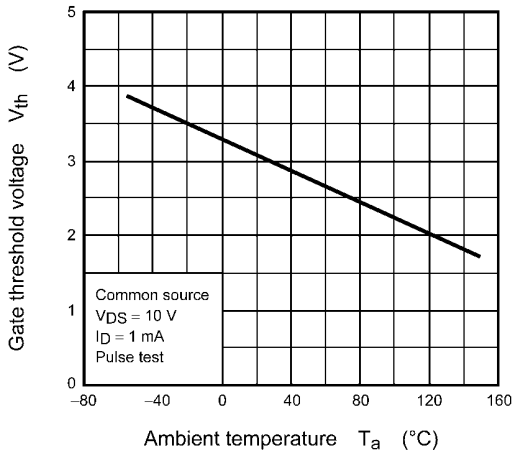


Fig. 8.10 V_{th} - T_a

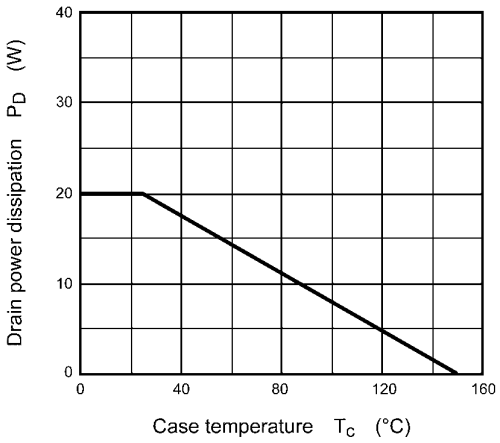


Fig. 8.11 P_D - T_c
(Guaranteed Maximum)

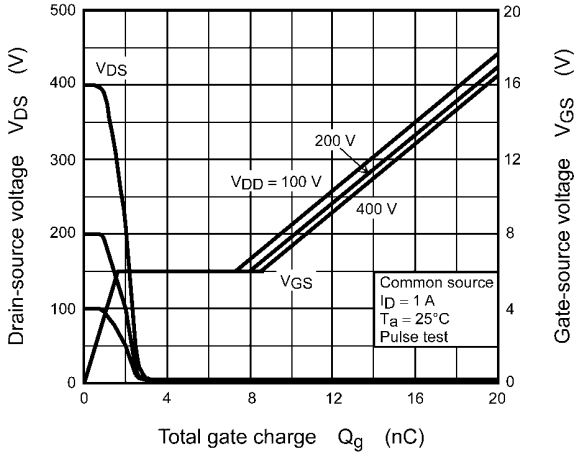


Fig. 8.12 Dynamic Input/Output Characteristics

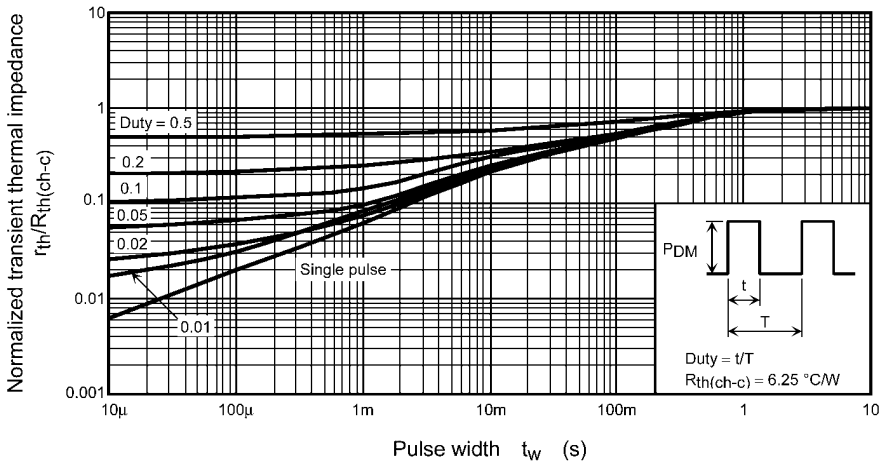


Fig. 8.13 $r_{th}/R_{th(ch-c)}$ - t_w (Guaranteed Maximum)

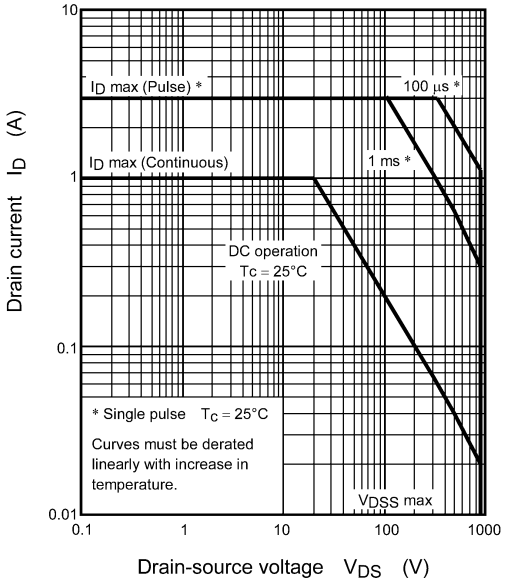


Fig. 8.14 Safe Operating Area (Guaranteed Maximum)

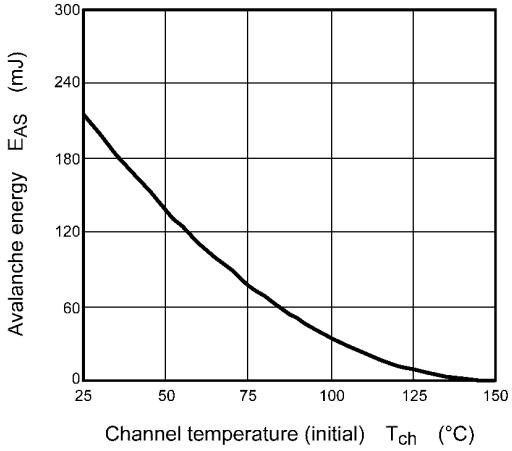
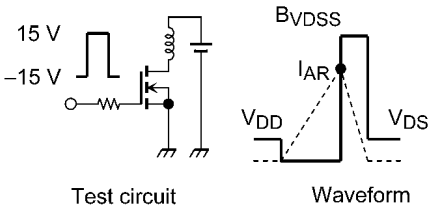


Fig. 8.15 E_{AS} - T_{ch} (Guaranteed Maximum)



$R_G = 25\ \Omega$
$V_{DD} = 90$ V, L = 396 mH

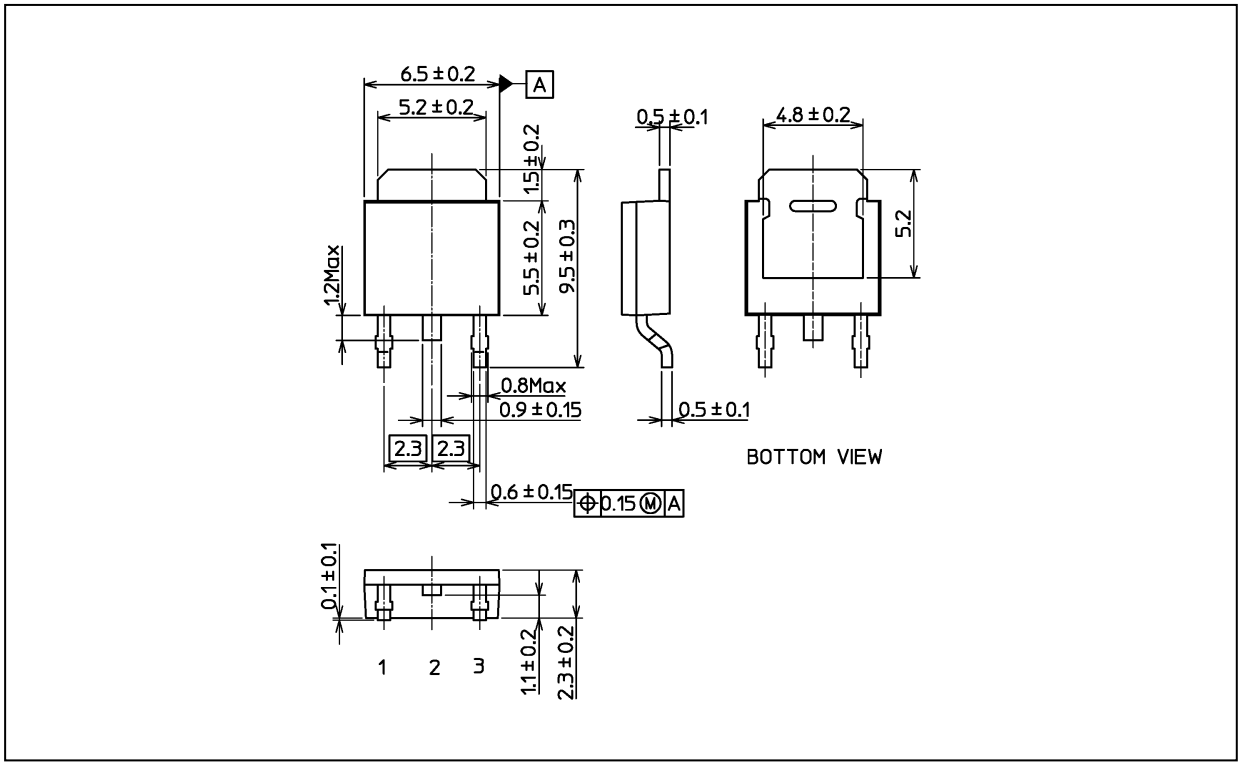
$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

Fig. 8.16 Test Circuit/Waveform

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 0.36 g (typ.)

Package Name(s)
TOSHIBA: 2-7J1S
Nickname: New PW-Mold

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